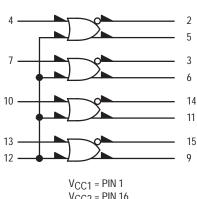
Quad OR/NOR Gate

The MC10101 is a quad 2–input OR/NOR gate with one input from each gate common to pin 12.

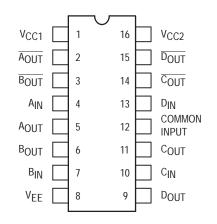
- $P_D = 25 \text{ mW typ/gate}$ (No Load)
- $t_{pd} = 2.0 \text{ ns typ}$
- t_{f} , $t_{f} = 2.0$ ns typ (20%-80%)



LOGIC DIAGRAM



DIP PIN ASSIGNMENT

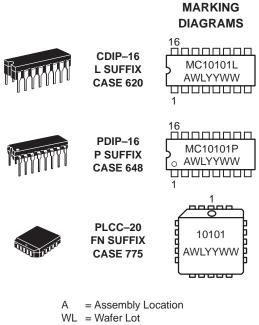


Pin assignment is for Dual–in–Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).



ON Semiconductor

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WL = Wafer Lot YY = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10101L	CDIP-16	25 Units / Rail
MC10101P	PDIP-16	25 Units / Rail
MC10101FN	PLCC-20	46 Units / Rail

ELECTRICAL CHARACTERISTICS

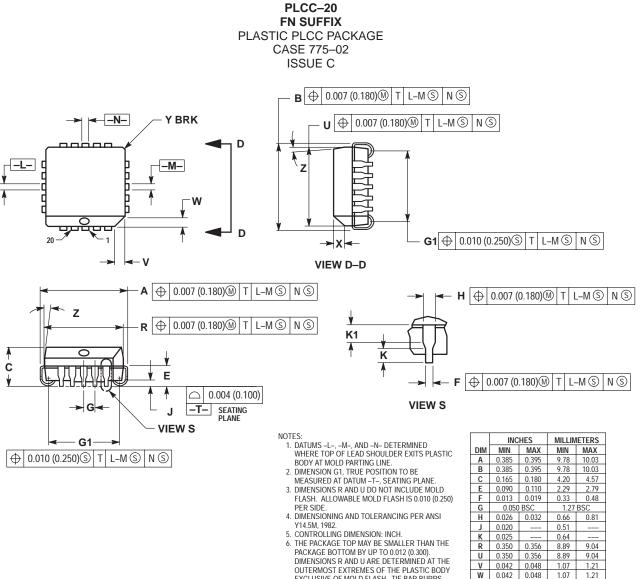
			Test Limits							
		Pin Under Test	–30°C		+25°C			+85°C		1
Characteristic	Symbol		Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply Drain Current	١ _E	8		29		20	26		29	mAdc
Input Current	linH	4 12		425 850			265 535		265 535	μAdc
	l _{inL}	4 12	0.5 0.5		0.5 0.5			0.3 0.3		μAdc
Output Voltage Logic 1	VOH	5 5 2 2	-1.060 -1.060 -1.060 -1.060	-0.890 -0.890 -0.890 -0.890	-0.960 -0.960 -0.960 -0.960		-0.810 -0.810 -0.810 -0.810	-0.890 -0.890 -0.890 -0.890	-0.700 -0.700 -0.700 -0.700	Vdc
Output Voltage Logic 0	VOL	5 5 2 2	-1.890 -1.890 -1.890 -1.890	-1.675 -1.675 -1.675 -1.675	-1.850 -1.850 -1.850 -1.850		-1.650 -1.650 -1.650 -1.650	-1.825 -1.825 -1.825 -1.825	-1.615 -1.615 -1.615 -1.615	Vdc
Threshold Voltage Logic 1	Vона	5 5 2 2	-1.080 -1.080 -1.080 -1.080		-0.980 -0.980 -0.980 -0.980			-0.910 -0.910 -0.910 -0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	5 5 2 2		-1.655 -1.655 -1.655 -1.655			-1.630 -1.630 -1.630 -1.630		-1.595 -1.595 -1.595 -1.595	Vdc
Switching Times (50 Ω Load)										ns
Propagation Delay	t4+2– t4–2+ t4+5+ t4–5–	2 2 5 5	1.0 1.0 1.0 1.0	3.1 3.1 3.1 3.1	1.0 1.0 1.0 1.0	2.0 2.0 2.0 2.0	2.9 2.9 2.9 2.9	1.0 1.0 1.0 1.0	3.3 3.3 3.3 3.3	
Rise Time (20 to 80%)	t ₂₊ t ₅₊	2 5	1.1 1.1	3.6 3.6	1.1 1.1	2.0 2.0	3.3 3.3	1.1 1.1	3.7 3.7	
Fall Time (20 to 80%)	t ₂₋ t ₅₋	2 5	1.1 1.1	3.6 3.6	1.1 1.1	2.0 2.0	3.3 3.3	1.1 1.1	3.7 3.7	

ELECTRICAL CHARACTERISTICS (continued)

		TEST VOLTAGE VALUES (Volts)							
		@ Test Te	mperature	VIHmax	VILmin	VIHAmin	VILAmax	VEE	1
			–30°C	-0.890	-1.890	-1.205	-1.500	-5.2	1
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	1
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	1
			Pin	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					1
Character	istic	Symbol	Under Test	VIHmax	V _{ILmin}	VIHAmin	VILAmax	VEE	(V _{CC}) Gnd
Power Supply Drain (Current	١E	8					8	1, 16
Input Current		l _{inH}	4 12	4 12				8 8	1, 16 1, 16
		l _{inL}	4 12		4 12			8 8	1, 16 1, 16
Output Voltage	Logic 1	Vон	5 5 2 2	12 4				8 8 8 8	1, 16 1, 16 1, 16 1, 16 1, 16
Output Voltage	Logic 0	VOL	5 5 2 2	12 4				8 8 8 8	1, 16 1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 1	Voha	5 5 2 2			12 4	12 4	8 8 8 8	1, 16 1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 0	Vola	5 5 2 2			12 4	12 4	8 8 8 8	1, 16 1, 16 1, 16 1, 16 1, 16
Switching Times	(50Ω Load)					Pulse In	Pulse Out	–3.2 V	+2.0 V
Propagation Delay		t ₄₊₂ t ₄₋₂₊ t ₄₊₅₊ t ₄₋₅₋	2 2 5 5			4 4 4 4	2 2 5 5	8 8 8 8	1, 16 1, 16 1, 16 1, 16 1, 16
Rise Time	(20 to 80%)	t ₂₊ t5+	2 5			4 4	2 5	8 8	1, 16 1, 16
Fall Time	(20 to 80%)	t ₂₋ t5-	2 5			4 4	2 5	8 8	1, 16 1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS



PACKAGE BOTION BY DE TO UUT2 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY. DIMENSION H DOPS NOT INCLUDE DAMBAR

1.42

0.50

10 °

8.38

1.07

7.88

1.02

X 0.042 Y ----

K1 0.040

2° 10°

G1 0.310 0.330

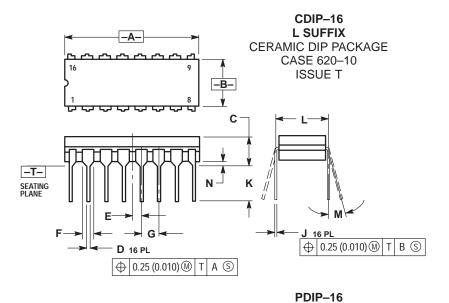
Ζ

0.056

0.020

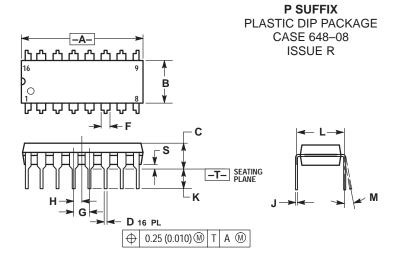
AND BOTTOM OF THE PLASTIC BODT. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

PACKAGE DIMENSIONS



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIMETERS			
DIM	MIN MAX		MIN	MAX		
Α	0.750	0.785	19.05	19.93		
В	0.240	0.295	6.10	7.49		
С		0.200		5.08		
D	0.015	0.020	0.39	0.50		
Ε	0.050	BSC	1.27 BSC			
F	0.055	0.065	1.40	1.65		
G	0.100 BSC		2.54 BSC			
Н	0.008	0.015	0.21	0.38		
К	0.125	0.170	3.18	4.31		
L	0.300 BSC		7.62 BSC			
М	0 °	15°	0 °	15 °		
Ν	0.020	0.040	0.51	1.01		



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100 BSC		2.54 BSC		
Н	0.050 BSC		1.27 BSC		
J	0.008	0.015	0.21	0.38	
К	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
Μ	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

<u>Notes</u>

<u>Notes</u>

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